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FACSIMILE TRANSMISSION COVER SHEET

DATE:

June 19, 2002

TO:

Examiner Howard Weiss

U. S. Patent and Trademark Office

RE:

Preliminary Amendment filed February 27, 2002

U.S. Patent Appln S.N. 10/050,169

By: IKEMASU et al.
Our Reference: 970607B

FROM:

Stephen G. Adrian

FAX NO.

703-746-3889

NUMBER OF PAGES (INCLUDING THIS COVER SHEET): //

PLEASE ACKNOWLEDGE SAFE AND CLEAR RECEIPT OF ALL PAGES BEING SENT

Dear Examiner Weiss:

Attached is a copy of the Preliminary Amendment filed February 27, 2002.

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CARD NO: 08961

U.S. Patent Application Serial No: (c/oso,/69

Docket No: 970607B

Patent Number:

Filed: 01/18/02 Issued:

Applicant(s): [KEMASU, et al

Papers filed herewith on: 02/27/02

Fees: 5 252.00

Other: Preliminary Associated: Associated Transmittel and Information Discissing Statement W/ 8 References



COMMISSIONER OF PATENTS

Receipt is hareby asknowledged of the papers filed as indicated in connection with the above-identified case. SCA/ARF

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

A. Exsel

In re the Application of: IKEMASU et 4

Serial Number: 10/050,169 V .

Filed: January 18, 2002 U

Prior Group Art Unit: 28

2814

For:

HIGHLY INTEGRATED AND RELIABLE DRAM

Prior Examiner: WEISS

AND ITS MANUFACTURE

PRELIMINARY AMENDMENT

Commissioner for Patents Washington, D.C. 20231

February 27, 2002

Sir:

1

Prior to examination of the above-identified divisional application, please amend the same as follows:

IN THE CLAIMS:

Please amend Claim 1, as follows:

- 1. (Amended) A semiconductor device comprising:
- a semiconductor substrate;
- a first insulating film formed over said semiconductor substrate;
- a capacitor formed over said first insulating film, and having one electrode which includes an extension extending over said first insulating film;
 - a second insulating film formed over said first insulating film;
- a first contact hole formed through said second insulating film and said extension of the one electrode; and
 - a first conductor pattern burying said first contact hole.